



Product Change Notice

Micron PCN: 31103
Date: 12/09/2013

Type of Change:	End of Life	
Title of Change:	EOL of 25nm 4GB and 8GB eMMC JEDEC 4.41/ 4.51 VFBGA 153b 11.5 x13x1.0mm – Mobile Market	
Description of Change:	Micron 25nm 4GB and 8GB eMMC JEDEC 4.41 / 4.51 VFBGA 153b 11.5 x13x1.0 mm products are being discontinued.	
Reason for Change:	Product portfolio optimization and market trend adaptation	
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Product Affected: 25nm 4GB and 8GB eMMC JEDEC 4.41/ 4.51 VFBGA 153b 11.5 x13x1.0 – Mobile Market

<u>Affected Micron Part Number</u>	<u>Suggested Replacement Part Number</u>
MTFC4GLYAM-WT	MTFC4GACAAEA-WT
MTFC4GLWAM-WT	(20nm 4GB eMMC JEDEC 4.51 WFBGA 153b 11.5 x13x0.8)
MTFC8GLYAM-WT	MTFC8GACAAEA-WT
MTFC8GLWAM-WT	(20nm 8GB eMMC JEDEC 4.51 WFBGA 153b 11.5 x13x0.8)

Micron Sites Affected: All Sites

Schedule for MPNs Being Discontinued:

Last Buy Date: 31-May-2014(*)
Last Ship Date: 30-Nov-2014

Schedule for MPNs Under Development:

Sample Available: 29-Dec-2013
Qual Data Available: 15-Feb-2014
Product Ship Date: 28-Feb-2014

* Orders placed prior to the LTB date are subject to current inventory levels, which may vary based on market conditions and customer demand. Early orders are encouraged